# imall

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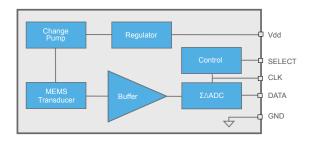
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## MULTIMODE DIGITAL BOTTOM PORT SISONIC™ MICROPHONE

The SPH0644LM4H-1 is a miniature, high-performance, low power, bottom port silicon digital microphone with a single bit PDM output. Using Knowles' proven high performance SiSonic<sup>™</sup> MEMS technology, the SPH0644LM4H-1 consists of an acoustic sensor, a low noise input buffer, and a sigma-delta modulator. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required. In addition, the SPH0644LM4H-1 offers multiple performance modes.



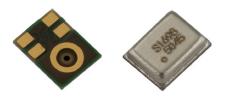
## ABSOLUTE MAXIMUM RATINGS

Table 1: Absolute Maximum Ratings

Parameter	Absolute Maximum Rating	Units
Vdd, DATA to Ground	-0.3, +5.0	V
CLOCK, SELECT to Ground	-0.3, +5.0	V
Input Current	±5	mA
Short Circuit to/from DATA	Indefinite to Ground or Vdd	sec
Temperature	-40 to +100	°C

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

## Knowles



## PRODUCT FEATURES

- Low Distortion /High AOP
- High SNR
- Low Current Consumption in
  Low-Power Mode
- Flat Frequency Response
- High Drive Capability
- RF Shielded
- Bottom Port
- Sensitivity Matching
- Supports Dual Multiplexed Channels
- Multiple Performance Modes (Sleep, Low-Power, Normal)
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional
- LGA Package

### TYPICAL APPLICATIONS

- Portable electronics
- Cellphones
- Laptop Computers
- Tablets
- Digital Still Cameras
- Portable Music Recorders





## ACOUSTIC & ELECTRICAL SPECIFICATIONS<sup>1</sup>

#### Table 2: General Microphone Specifications

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Supply Voltage	Vdd		1.6	1.8	3.6	V
DC Output		Fullscale = ±100	-	0	-	% FS
Directivity			Omnidirecti	onal		- ·
Polarity		Increasing sound pressure	Increasing o	lensity of 1's		
Data Format			1/2 Cycle PD	М		
Sensitivity Drop		$Vdd(min) \le Vdd \le Vdd(max)$	-	-	±0.25	dB
Clock Input Capacitance	Cin		-	5	-	pF
SELECT (high)			Vdd-0.2	-	3.6	V
SELECT (low)			-0.3	-	0.2	V
SELECT Sample Time		After power up, Vdd = Vdd(min)	-	50	-	ms
Short Circuit Current	lsc	Grounded DATA pin	1	-	20	mA
Output Load	Cload		-	-	140	pF
Fall-asleep Time <sup>2,3</sup>		Fclock < 250 KHz	-	-	10	ms
Wake-up Time <sup>2,4</sup>		$Fclock \ge 500 \text{ KHz}$	-	-	35	ms
Startup Time <sup>2</sup>		Powered Down $\rightarrow$ Active Mode	-	-	50	ms
Mode-Change Time <sup>2</sup>		Audio is muted	-	-	16	ms

<sup>1</sup> Sensitivity and Supply Current are 100% tested.

<sup>2</sup> Valid microphones states are: Powered Down Mode (mic off), Sleep Mode (low current, DATA = high-Z, fast startup), Low-Power Mode (low clock speed) and Normal Mode.

<sup>a</sup> Time from Fclock < 250 kHz to Isleep specification is met when transitioning from Active Mode to Sleep Mode.

<sup>4</sup> Time from Fclock ≥ 500 kHz to all applicable specifications are met when transitioning from Sleep Mode to Active Mode.





#### Table 3: Normal Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 2.4MHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Тур	Max	Units
		Fclock = 1.536 MHz	-	685	850	
Supply Current <sup>5</sup>	Idd	Fclock = 2.4 MHz	-	900	1100	μA
		Fclock = 3.072 MHz	-	1130	1400	
Sensitivity	S	94 dB SPL @ 1 kHz	-38	-37	-36	dBFS
Signal to Noise Ratio	SNR	94 dB SPL @ 1 kHz, A-weighted	-	65.5	-	dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1 kHz	-	0.2	-	%
		1% THD @ 1 kHz, S = typ	-	114.5	-	dB SPL
Acoustic Overload Point	AOP	10% THD @ 1 kHz, S = typ	-	132.5	-	dB SPL
Low Frequency Rolloff	LFRO	-3dB relative to 1 kHz	-	35	-	Hz
Power Supply Rejection Ratio	PSRR	200 mVpp sinewave @ 1 kHz	-	87	-	dB V/FS
Power Supply Rejection	PSR+N	200 mVpp 7/8 duty cycle rectangular waveform @ 217 Hz, A-weighted, BW = 20 kHz	-	-97	-	dBFS(A)

<sup>5</sup> Idd varies with Cload according to:  $\Delta$ Idd = 0.5\*Vdd\* $\Delta$ Cload\*Fclock.

#### Table 4: Low-Power Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 768kHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Supply Current⁵	Idd		-	255	320	μA
Sensitivity	S	94 dB SPL @ 1 kHz	-22	-21	-20	dBFS
Signal to Noise Ratio	SNR	94 dB SPL @ 1 kHz, A-weighted (BW = 8 kHz)	-	64.5	-	dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1 kHz	-	0.2	-	%
		1% THD @ 1 kHz, S = typ		113		dB SPL
Acoustic Overload Point	AOP	10% THD @ 1 kHz, S = typ	-	116.5	-	dB SPL
Low Frequency Rolloff	LFRO	-3dB relative to 1 kHz	-	35	-	Hz
Power Supply Rejection Ratio	PSRR	200 mVpp sinewave @ 1 kHz	-	76	-	dBV/FS
Power Supply Rejection	PSR+N	200 mVpp 7/8 duty cycle rectangular waveform @ 217 Hz, A-weighted, BW = 8 kHz	-	-85		dBFS(A)

 $^5$  Idd varies with Cload according to:  $\Delta Idd$  = 0.5\*Vdd\* $\Delta Cload*$ Fclock.





#### Table 5: Sleep Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 250kHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Clean Current	Jalaan	Fclock = 0 Hz	-	50	-	
Sleep Current	Isleep	Fclock = 250 kHz	-	54	80	μΑ

#### Table 6: Digital Interface

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Logic Input High <sup>6</sup>	Vih		0.65xVdd	-	3.6	V
Logic Input Low <sup>6</sup>	Vil		-0.3	-	0.35xVdd	V
Logic Output High <sup>6</sup>	Voh	I <sub>out</sub> = 2 mA	Vdd-0.45	-	Vdd	V
Logic Output Low <sup>6</sup>	Vol	I <sub>out</sub> = 2 mA	0	-	0.45	V
Low→High Threshold <sup>7</sup>	VI-h		-	-	0.65xVdd	V
High→Low Threshold <sup>7</sup>	Vh-l		0.35xVdd	-	-	V
Hysteresis Width <sup>7</sup>	Vhyst		0.05xVdd	-	0.20xVdd	V
		Sleep Mode	0	-	280	
Clock Frequency <sup>6</sup>	Fclock	Low Power Mode	500	-	1200	kHz
		Normal Mode	1400	-	4800	
	5.0	Fclock < 3 MHz	40	50	60	
Clock Duty Cycle D.C.		Fclock ≥ 3 MHz	48	50	52	%
Delay Time to Data Line Driven <sup>6</sup>	Tdd		18	-	35	ns
Delay Time to Valid Data <sup>6</sup>	Tdv	Max Cload	-	-	100	ns
Delay Time to High Z <sup>6,8</sup>	Tdz		5	-	16	ns

<sup>6</sup> See Figure 1: Timing Diagram.

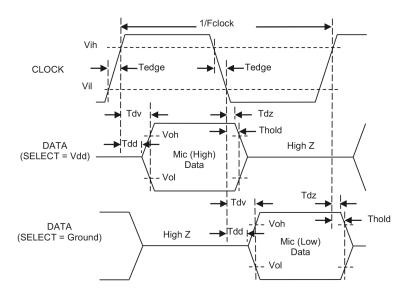
<sup>7</sup> See Figure 2: Hysteresis Diagram.

<sup>8</sup> Thold can be dependent on Cload.

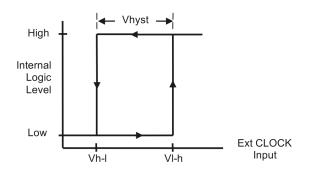




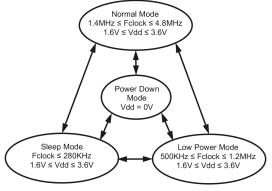
#### Figure 1: Timing Diagram



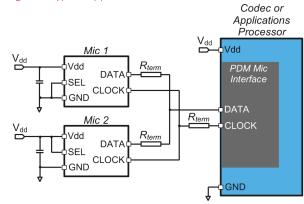
#### Figure 2: Hysteresis Diagram



#### Figure 4: State Diagram



#### Figure 3: Typical Application Circuit



#### NOTES:

All Ground pins must be connected to ground. Bypass capacitors should be placed next to each Vdd pin for best performance.

Capacitors near the microphone should not contain Class 2 dielectrics due to their piezoelectric effect.

Detailed information on acoustic, mechanical, and system integration can be found in the latest SiSonic<sup>™</sup> Design Guide application note.

#### Table 7: SELECT Functionality

Microphone	SELECT	Asserts DATA on	Latch DATA on
Mic (High)	Vdd	CLK rising edge	CLK falling edge
Mic (Low)	Ground	CLK falling edge	CLK rising edge





## PERFORMANCE CURVES

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 2.4MHz, SELECT grounded, no load, unless otherwise indicated

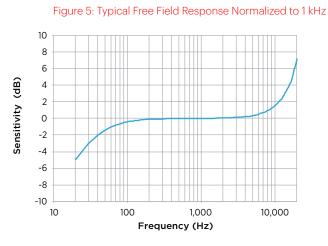


Figure 7: Typical Free Field Response Normalized to 1 kHz

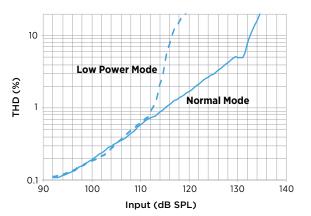


Figure 9: Typical THD vs Frequency

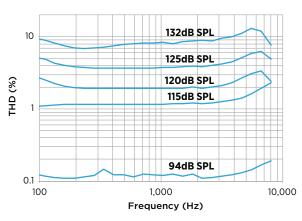


Figure 6: Typical PSRR

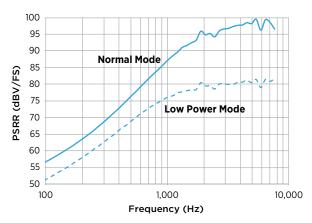


Figure 8: Typical Idd vs Vdd

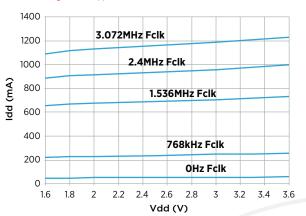
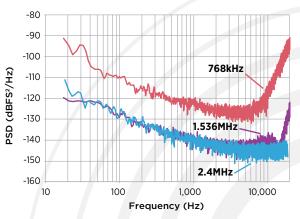
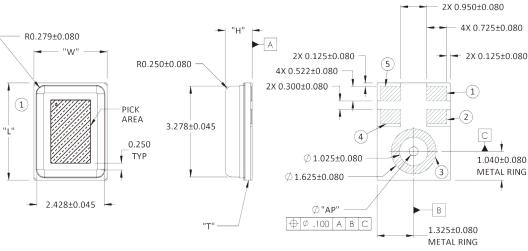


Figure 10: Noise Floor Power Spectral Density





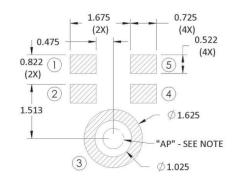
## MECHANICAL SPECIFICATIONS



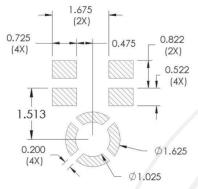
Item	Dimension	Tolerance
Length (L)	3.50	±0.10
Width (W)	2.65	±0.10
Height (H)	0.98	±0.10
Acoustic Port (AP)	Ø0.325	±0.05
PCB Thickness (T)	0.307	±0.05

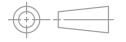
Pin #	Pin Name	Туре	Description
1	DATA	Digital O	PDM Output
2	SELECT	Non-Digital I	Lo/Hi (L/R) Select Connect to Vdd or GND
3	GROUND	Power	Ground
4	CLOCK	Digital I	Clock Input
5	Vdd	Power	Power Supply. Pull low to turn off and do not leave floating.

### **Example Land Pattern**



### **Example Solder Stencil Pattern**





#### NOTES:

Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified. Dimensions are in millimeters unless otherwise specified. Tolerance is ±0.15mm unless otherwise specified.

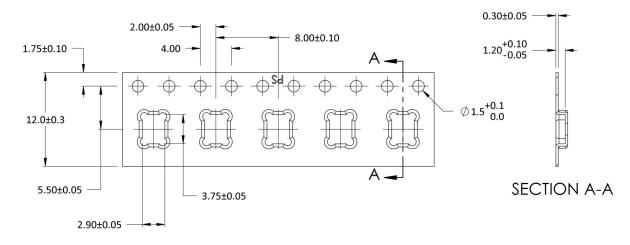
Detailed information on AP size considerations can be found in the latest SiSonic™ Design Guide application note.

Further optimizations based on application should be performed.





## **PACKAGING & MARKING DETAIL**



Model Number	Suffix	Reel Diameter	Quantity Per Reel
SPH0644LM4H-1	-8	13"	5,900

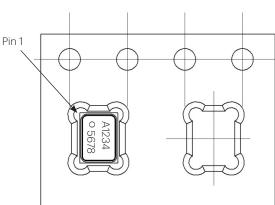
Component	Surface Resistance (ohms)
Reel	10 <sup>5</sup> - 10 <sup>9</sup>
Carrier Tape	10 <sup>5</sup> - 10 <sup>9</sup>
Cover Tape	104 - 1010

#### "o": orientation mark

- Alpha Character A:
  - "S": Knowles SiSonic™ Production
  - "E": Knowles Engineering Samples
  - "P": Knowles Prototype Samples

"12345678":

Unique Job Identification Number for product traceability



#### NOTES:

Dimensions are in millimeters unless otherwise specified.

Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481.

Labels applied directly to reel and external package.

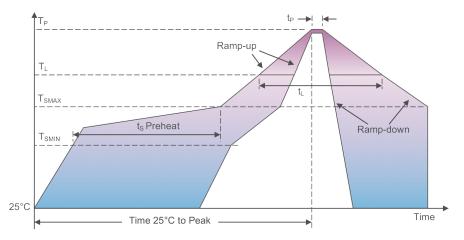
Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under

maximum environmental conditions of 30°C, 70% R.H.





## RECOMMENDED REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate (TSMAX to TP)	3°C/second max.
Preheat • Temperature Min (TSMIN) • Temperature Max (TSMAX) • Time (TSMIN to TSMAX) (tS)	150°C 200°C 60-180 seconds
Time maintained above: • Temperature (TL) • Time (tL)	217°C 60-150 seconds
Peak Temperature (TP)	260°C
Time within 5°C of actual Peak Temperature (tP)	20-40 seconds
Ramp-down rate (TP to TSMAX)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

#### NOTES:

Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

#### ADDITIONAL NOTES:

- (A) MSL (moisture sensitivity level) Class 1.
- (B) Maximum of 3 reflow cycles is recommended.
- (C) In order to minimize device damage:
  - Do not board wash or clean after the reflow process.
  - Do not brush board with or without solvents after the reflow process.
  - Do not directly expose to ultrasonic processing, welding, or cleaning.
  - Do not insert any object in port hole of device at any time.
  - Do not apply over 30 psi of air pressure into the port hole.
  - Do not pull a vacuum over port hole of the microphone.
  - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.





## MATERIALS STATEMENT

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Product is Beryllium Free according to limits specified on the Knowles Hazardous Material List (HSL for Products).

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the "Montreal Protocol on Substances That Deplete the Ozone Layer."

## RELIABILITY SPECIFICATIONS

Test	Description	
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks (IEC 68-2-4)	
High Temperature Storage	+105°C environment for 1,000 hours (IEC 68-2-2 Test Ba)	
Low Temperature Storage	-40°C environment for 1,000 hours (IEC 68-2-1 Test Aa)	
High Temperature Bias	+105°C environment while under bias for 1,000 hours (IEC 68-2-2 Test Ba)	
Low Temperature Bias	-40°C environment while under bias for 1,000 hours (IEC 68-2-1 Test Aa)	
Temperature/Humidity Bias	+85°C/85% R.H. environment while under bias for 1,000 hours (JESD22-A101A-B)	
Vibration	12 minutes in each X, Y, Z axis from 20 to 2,000 Hz with peak acceleration of 20 G (MIL 883E, Method 2007.2,A)	
ESD-HBM	3 discharges at ±2kV direct contact to I/O pins (ESD STM5.2)	
ESD-LID/GND	3 discharges at ±8kV direct contact to lid when unit is grounded (IEC 61000-4-2)	
ESD-MM	3 discharges at ±200V direct contact to IO pins (MIL 883E, Method 3015.7)	
Reflow	5 reflow cycles with peak temperature of +260°C	
Mechanical Shock	3 pulses of 10,000 G in each of the X, Y, and Z directions (IEC 68-2-27 Test Ea)	

#### NOTES:

Microphones meet all acoustic and electrical specifications before and after reliability testing, except sensitivity which can deviate up to 3dB. After 3 reflow cycles, the sensitivity of the microphones shall not deviate more than 1 dB from its initial value.





## SPECIFICATION REVISIONS

Revision	Specification Changes	Date
А	Initial Release (ECR 16-955)	6/24/16
В	Corrected Idd(max) in Sleep Mode, Tdd(max); clarified center to edge tolerance; reliability clarification; reduced can X/Y tolerance to 0.045mm (ECR 16-1247)	10/26/16
С	Updated Carrier Tape (ECR 17-1928)	9/28/17

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Knowles Corporation 1151 Maplewood Drive Itasca, Illinois 60143 Phone: 1 (630) 250-5100 Fax: 1 (630) 250-0575 sales@knowles.com Model/Reference Number: Datasheet SPH0644LM4H-1 Rev C © Copyright 2017 Knowles

